

Studies on Plasma-Enhanced Atomic Layer Deposition of SIS Multilayers for Use in SRF Cavities

PhD Thesis Defense

Isabel González Díaz-Palacio

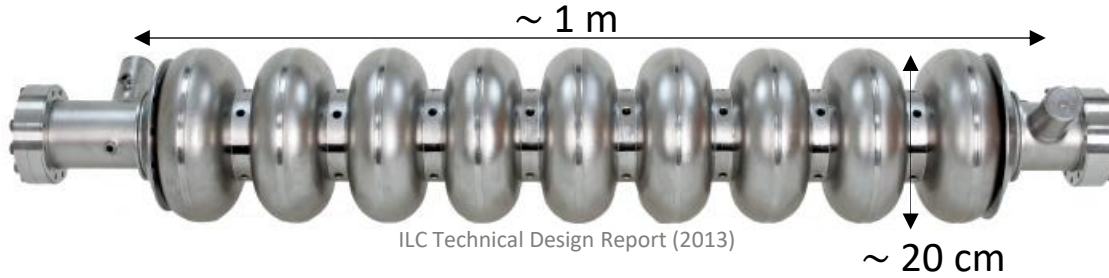
Universität Hamburg

05.03.2025



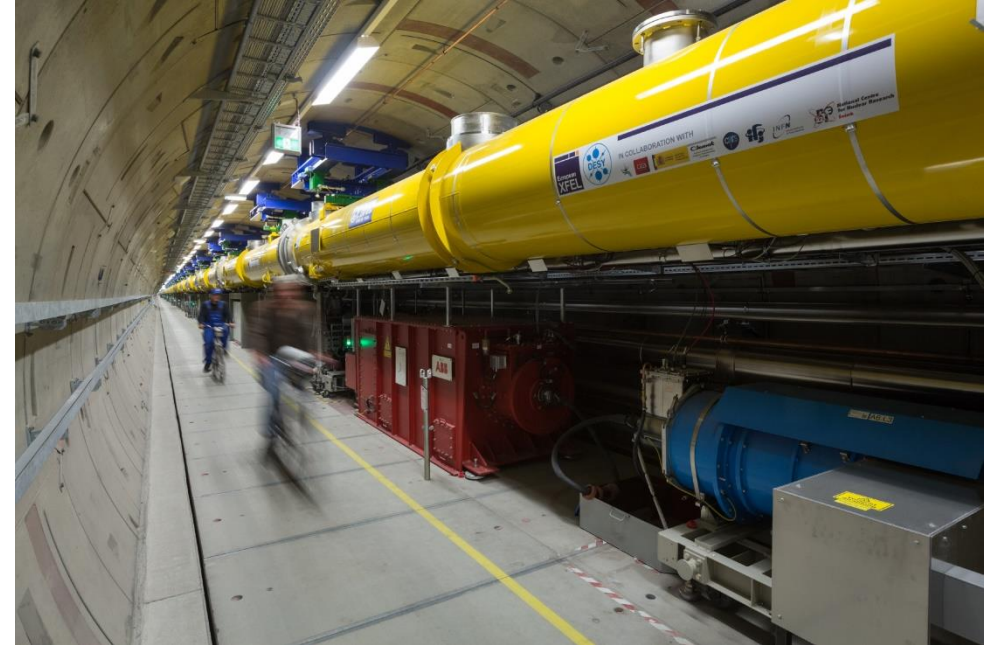
Superconducting RF (SRF) cavities for beam acceleration

1.3 GHz 9-cell TESLA cavity



Quality factor: $Q_0 \propto \frac{1}{R_S}$ Accelerating gradient: $E_{\text{acc}} \propto B_{\text{RF}}$

Operating at 2K in the Meissner state



Cryomodule in the Eu-XFEL tunnel <https://media.desy.de/>

Nb is the material of choice for SRF cavities



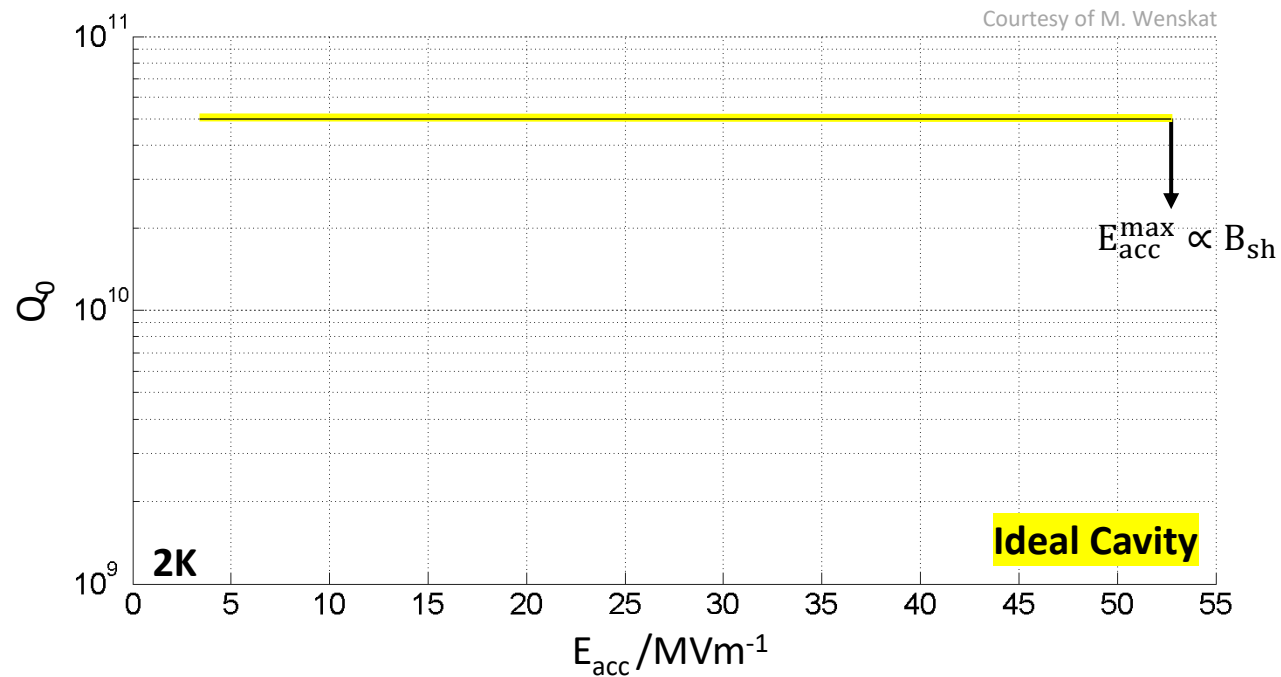
Niobium

$$B_{c1} \approx 180 \text{ mT} < B_{sh} \approx 220 \text{ mT} < B_{c2} \approx 400 \text{ mT}$$

$$T_c \approx 9.2 \text{ K}$$

good thermal, mechanical, and chemical properties

Quality factor: $Q_0 \propto \frac{1}{R_s}$ Accelerating gradient: $E_{acc} \propto B_{RF}$



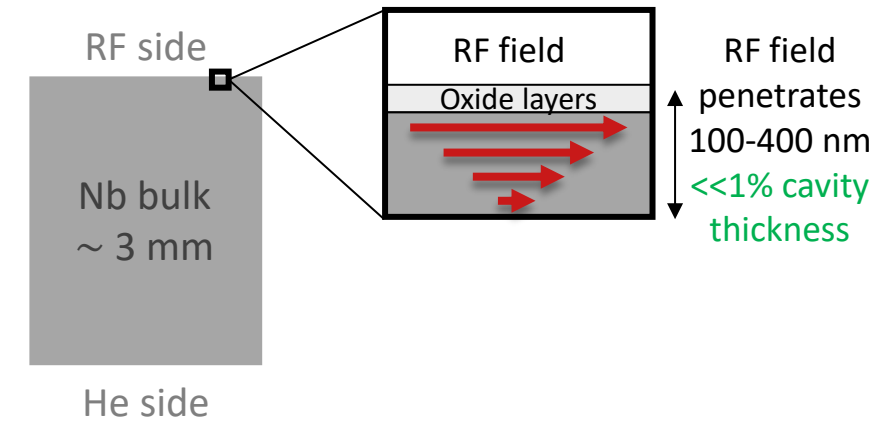
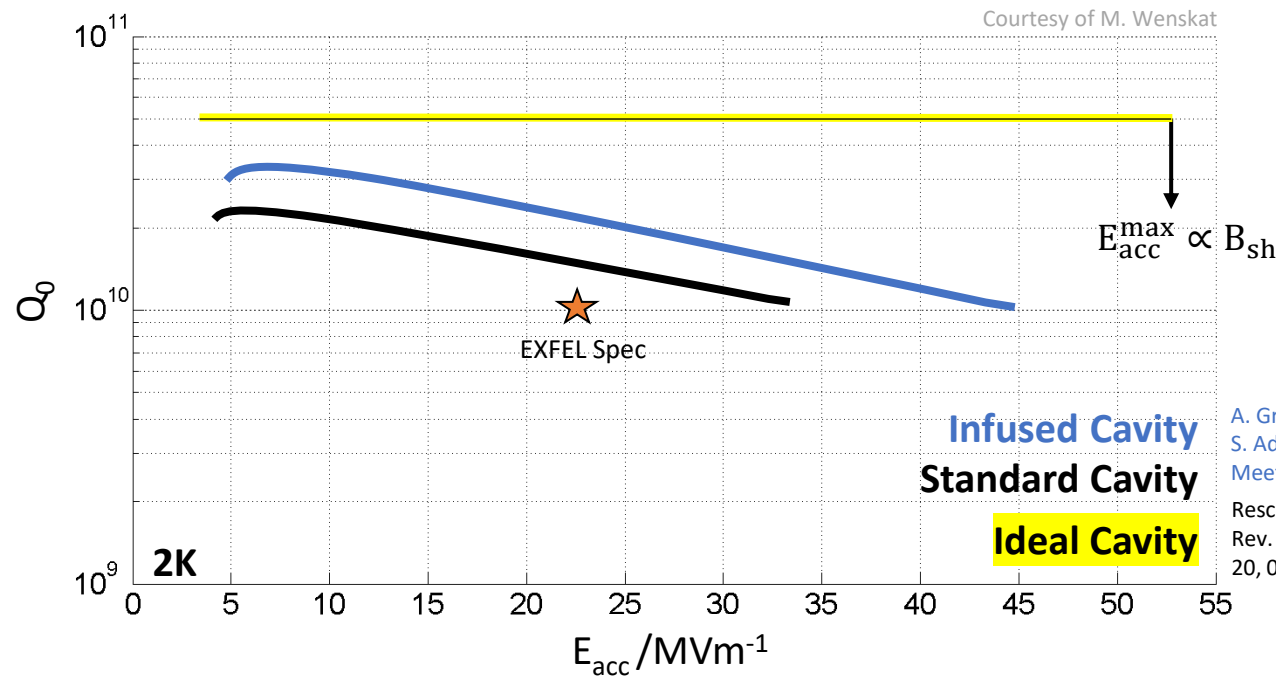
Cavity surface treatments are crucial for the RF performance



Niobium

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Quality factor: $Q_0 \propto \frac{1}{R_s}$ Accelerating gradient: $E_{acc} \propto B_{RF}$



A. Grassellino and
 S. Aderhold. TTC
 Meeting (2016)

Reschke et al., Phys.
 Rev. Accel. Beams,
 20, 042004 (2017)

Cavity surface treatments are crucial for the RF performance



Niobium

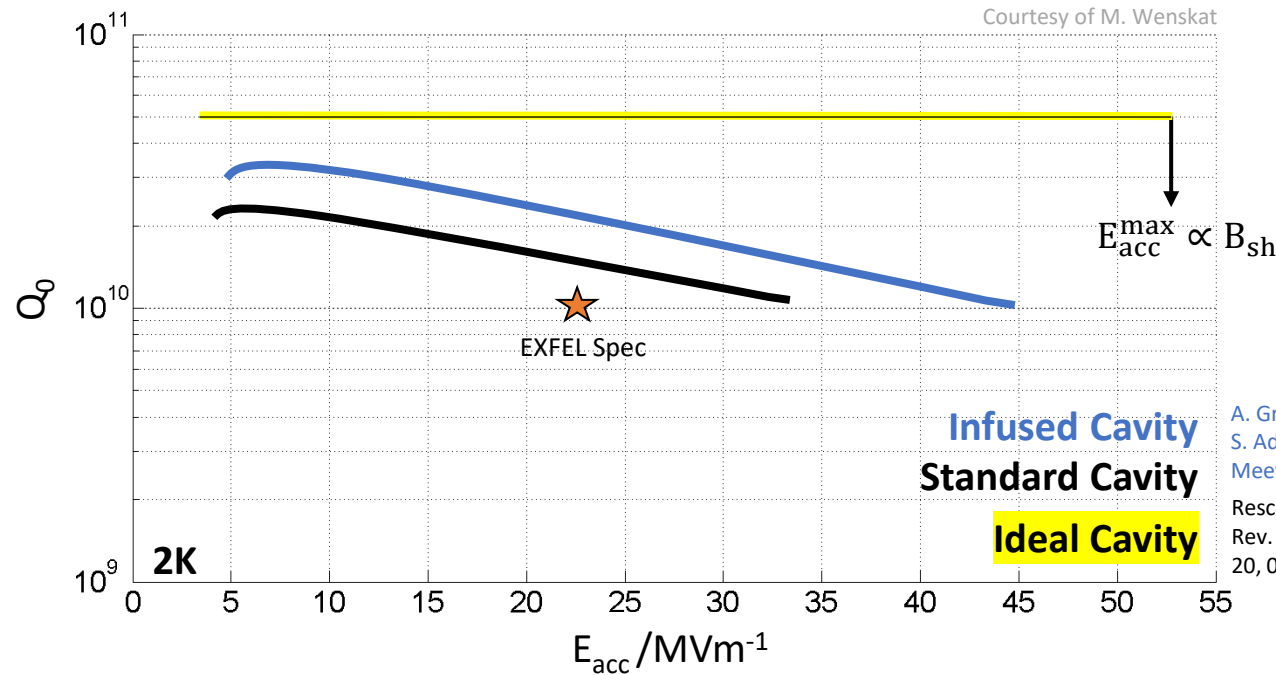
$$E_{\text{acc}}^{\text{max}} \sim 50 - 55 \text{ MV/m}$$

$$B_{\text{c1}} \approx 180 \text{ mT} < B_{\text{sh}} \approx 220 \text{ mT} < B_{\text{c2}} \approx 400 \text{ mT}$$

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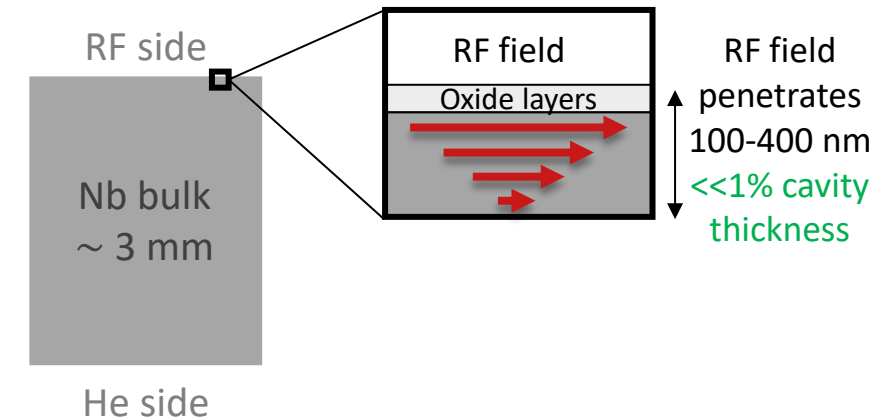
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A. Grassellino and S. Aderhold. TTC Meeting (2016)

Reschke et al., Phys. Rev. Accel. Beams, 20, 042004 (2017)



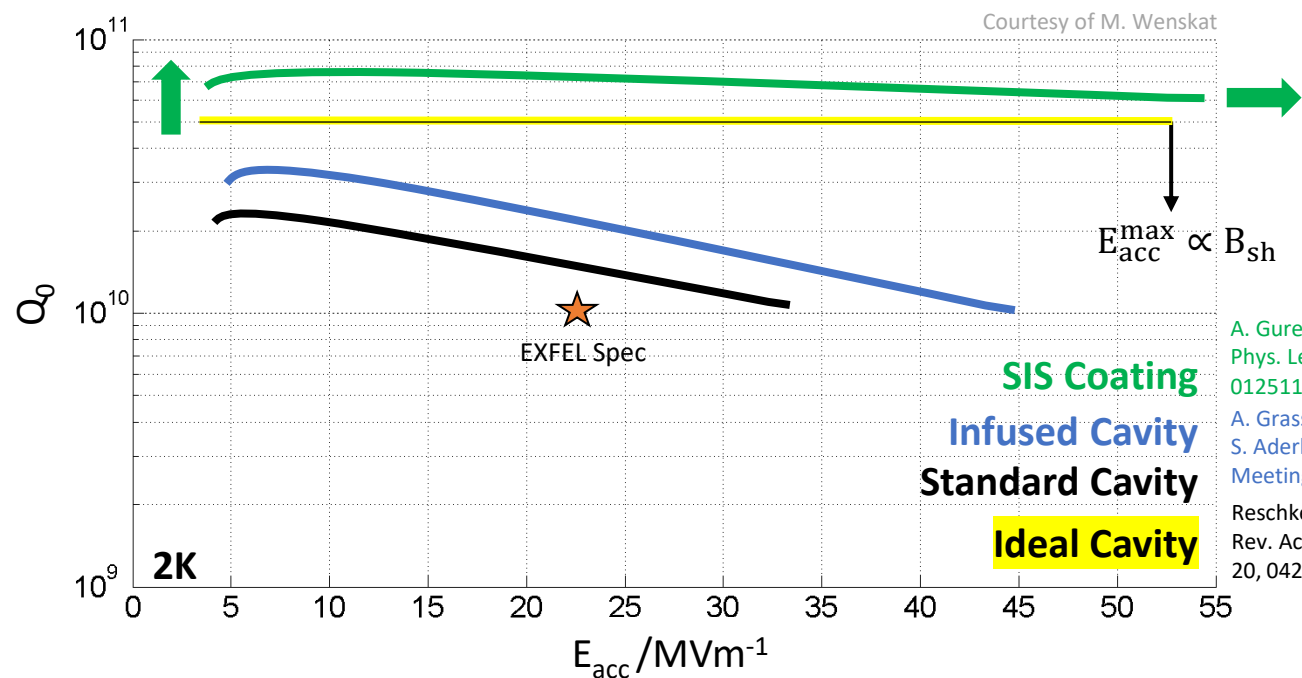
Higher accelerating gradients demand

new strategies beyond bulk Nb

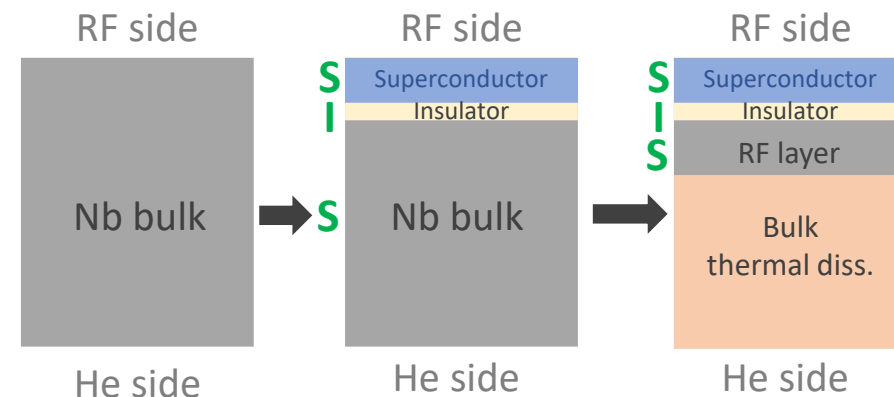
Pushing SRF cavities performance beyond Nb limits: SIS coating



Quality factor: $Q_0 \propto \frac{1}{R_s}$ Accelerating gradient: $E_{acc} \propto B_{RF}$



Modify the RF surface coating
superconductor-insulator-superconductor
 (SIS) multilayers



Future?

A. Gurevich, Appl. Phys. Lett. 88, 012511 (2006)
 A. Grassellino and S. Aderhold. TTC Meeting (2016)
 Reschke et al., Phys. Rev. Accel. Beams, 20, 042004 (2017)

S-layer for potential reduction of surface resistance

$$B_{c1}^{\text{Nb}} \approx 180 \text{ mT} ; B_{c2}^{\text{Nb}} \approx 400 \text{ mT}$$

➤ Higher $Q_0 \propto \frac{1}{R_s}$

$$R_s = R_{\text{BCS}}(T) + R_{\text{res}}$$

Superconductor	T _c (K)	ρ _n (μΩcm)	B _{c1} (mT)	B _{c2} (mT)	λ (nm)
<u>δ-NbTiN</u>	17.8	35	30	20000	150-200
δ-NbN	17.1	70	20	15000	200-350
Nb ₃ Sn	18.3	50	50	30000	80-100

Material candidates for I-layer

➤ I: AlN, Al₂O₃, MgO, etc

$$B_{c1}^{\text{layer}} > B_{c1}^{\text{Bulk}}$$

$$d_{\text{S-layer}} < \lambda_L$$

C.Z. Antoine SRF 2019 Tutorials

SIS multilayers as shielding for Nb cavities

$$B_{c1}^{\text{Nb}} \approx 180 \text{ mT} ; B_{c2}^{\text{Nb}} \approx 400 \text{ mT}$$

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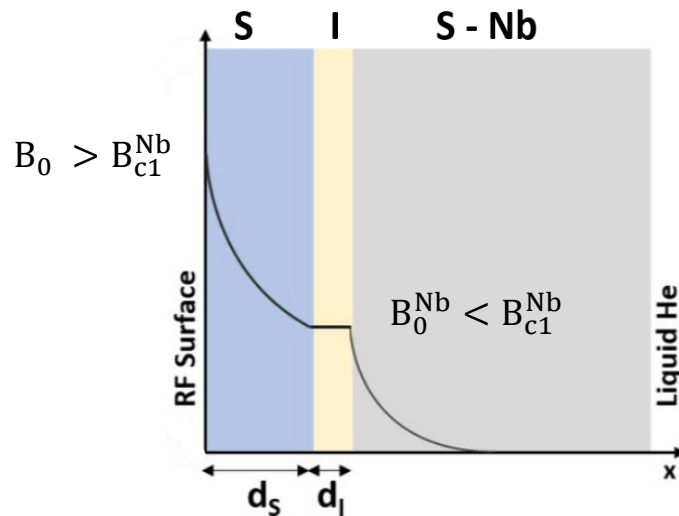
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$$B_{c1}^{\text{layer}} > B_{c1}^{\text{Bulk}}$$

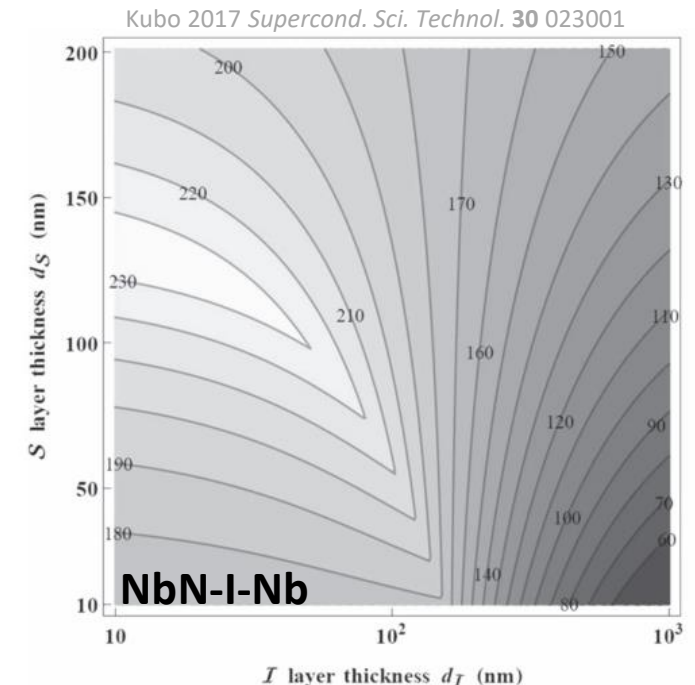
$$d_{\text{S-layer}} < \lambda_L$$

C.Z. Antoine SRF 2019 Tutorials

- Higher $E_{\text{acc}} \propto B_{\text{RF}}$



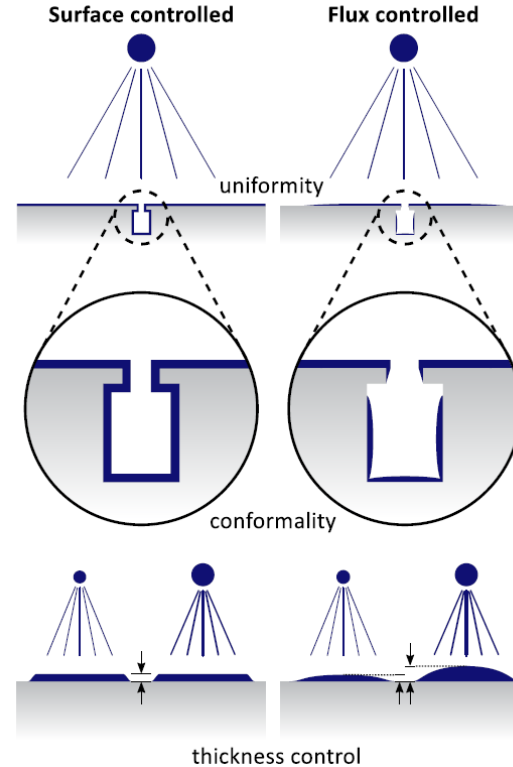
The shielding effect increases with the number of multilayers $(SI)^N - S$



The SIS multilayer approach requires experimental validation

Smooth, homogeneous, and conformal deposition is required

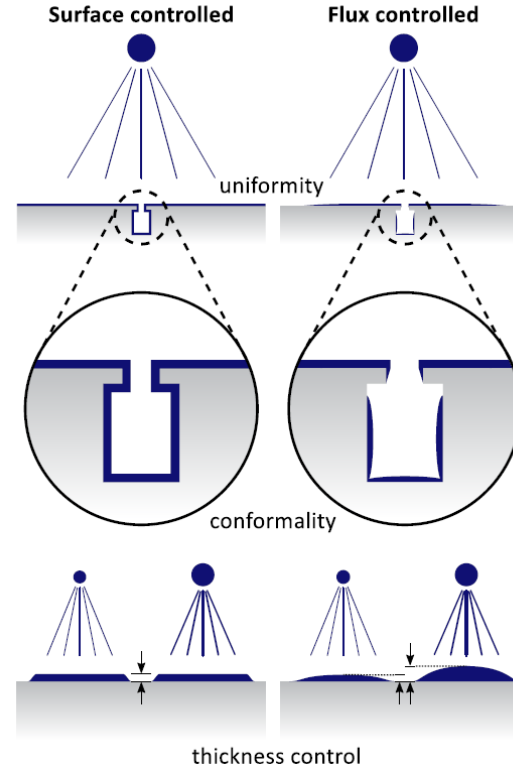
Thermal ALD and PEALD (Surface controlled) Line-of-sight (Flux controlled) (sputtering)



Arts, K. (2021) Eindhoven University of Technology

Line-of-sight: difficult to scale up to cavity geometry

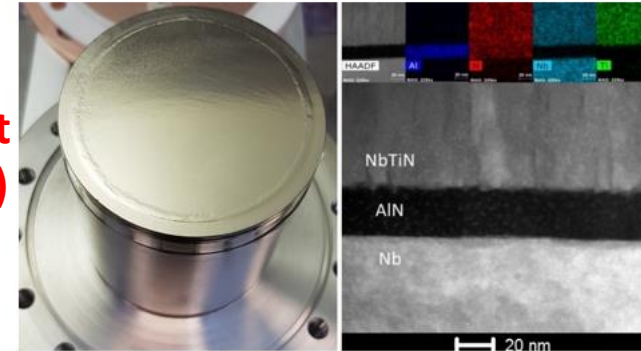
Thermal ALD and PEALD (green)
Line-of-sight (sputtering) (red)



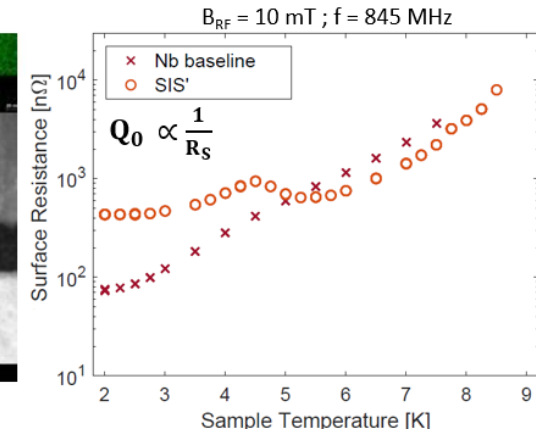
Arts, K. (2021) Eindhoven University of Technology

Progress on planar samples

AlN-NbTiN by DC magnetron sputtering

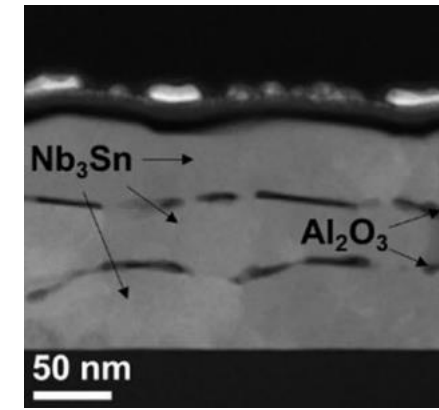


S. Keckert (2019), Dissertation, Universität Siegen

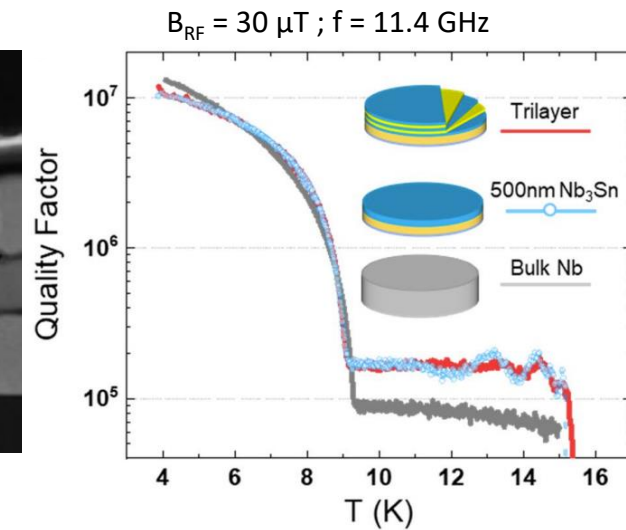


Nb₃Sn/Al₂O₃

by DC magnetron sputtering



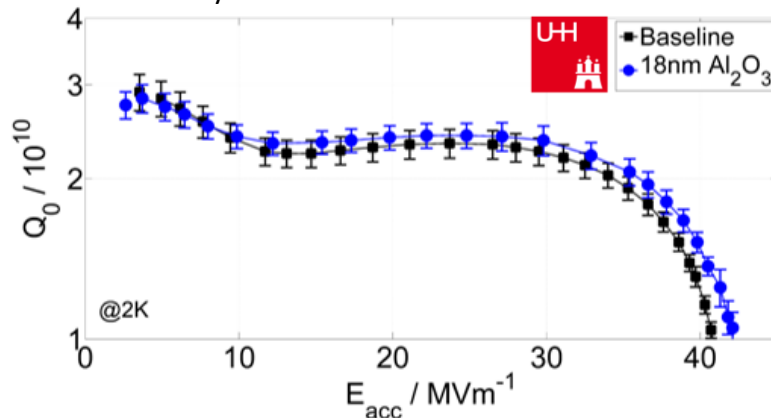
Sundahl, C., *Sci Rep* 11, 7770 (2021)



Thermal ALD and PEALD: easier to scale up to cavity geometry

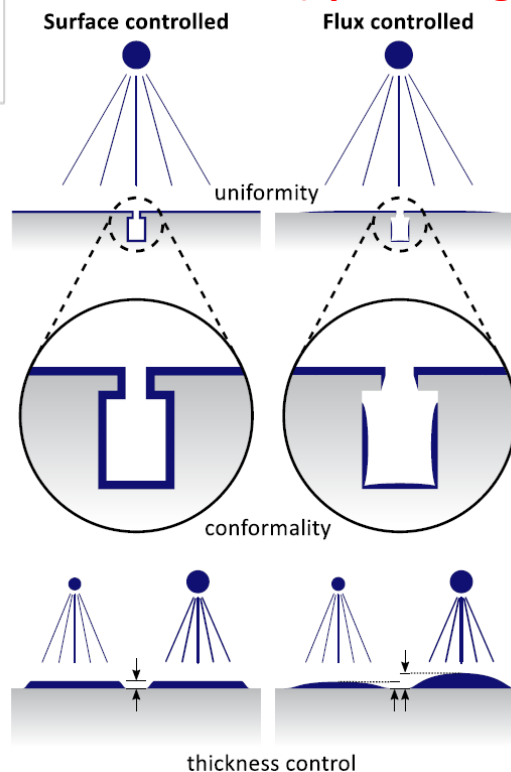
Progress on cavities

Al_2O_3 by thermal ALD



Marc Wenskat et al 2023 Supercond. Sci. Technol. 36 015010

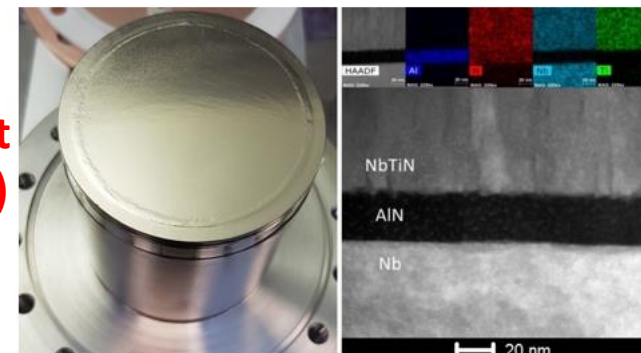
Thermal ALD and PEALD (sputtering)



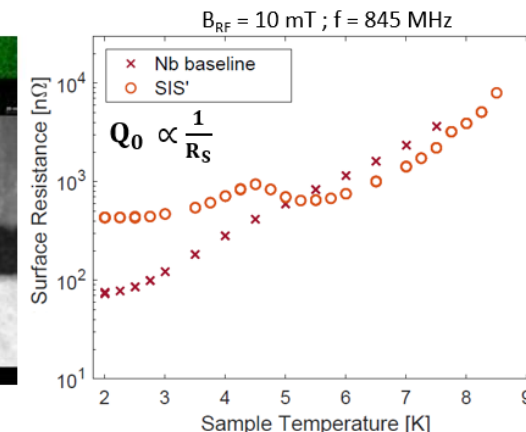
Arts, K. (2021) Eindhoven University of Technology

Progress on planar samples

AlN-NbTiN by DC magnetron sputtering

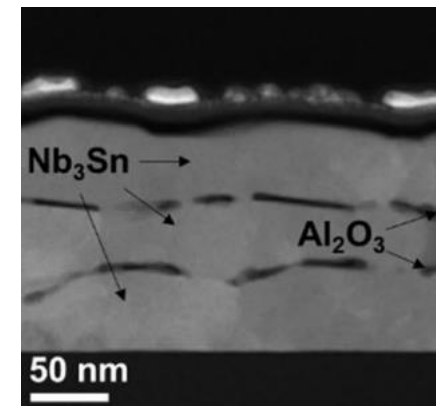


S. Keckert (2019), Dissertation, Universität Siegen

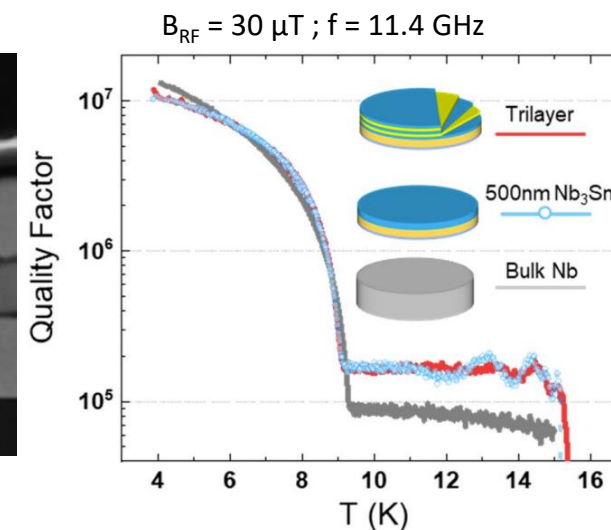


$\text{Nb}_3\text{Sn}/\text{Al}_2\text{O}_3$

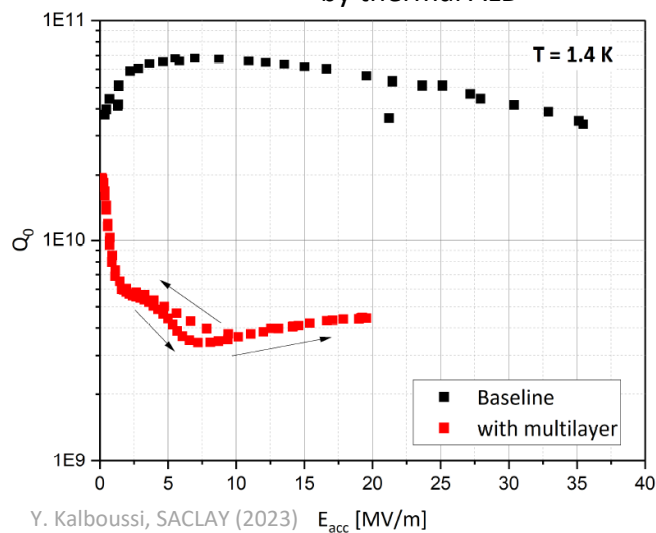
by DC magnetron sputtering



Sundahl, C., Sci Rep 11, 7770 (2021)



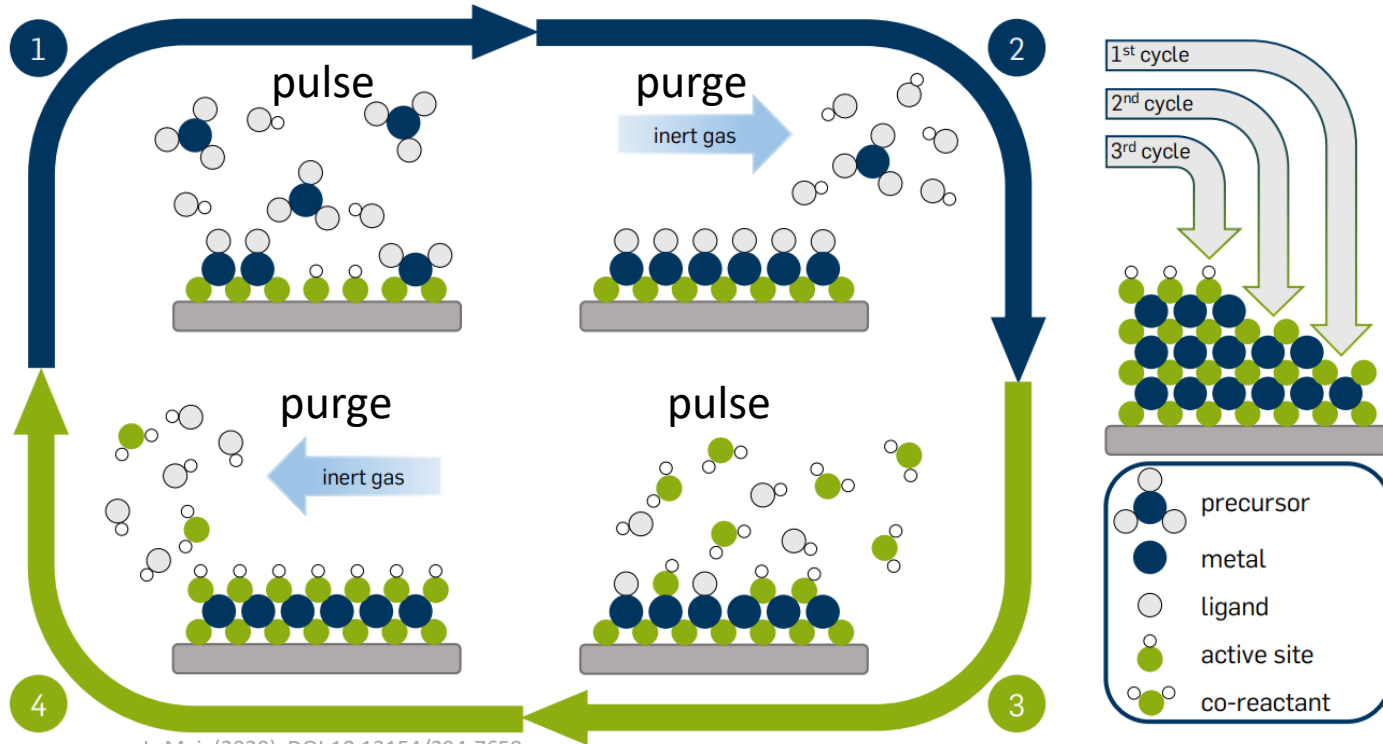
NbTiN/AlN by thermal ALD



Y. Kalboussi, SACLAY (2023) $E_{\text{acc}} [\text{MV/m}]$

Thermal ALD vs plasma-enhanced ALD (PEALD)

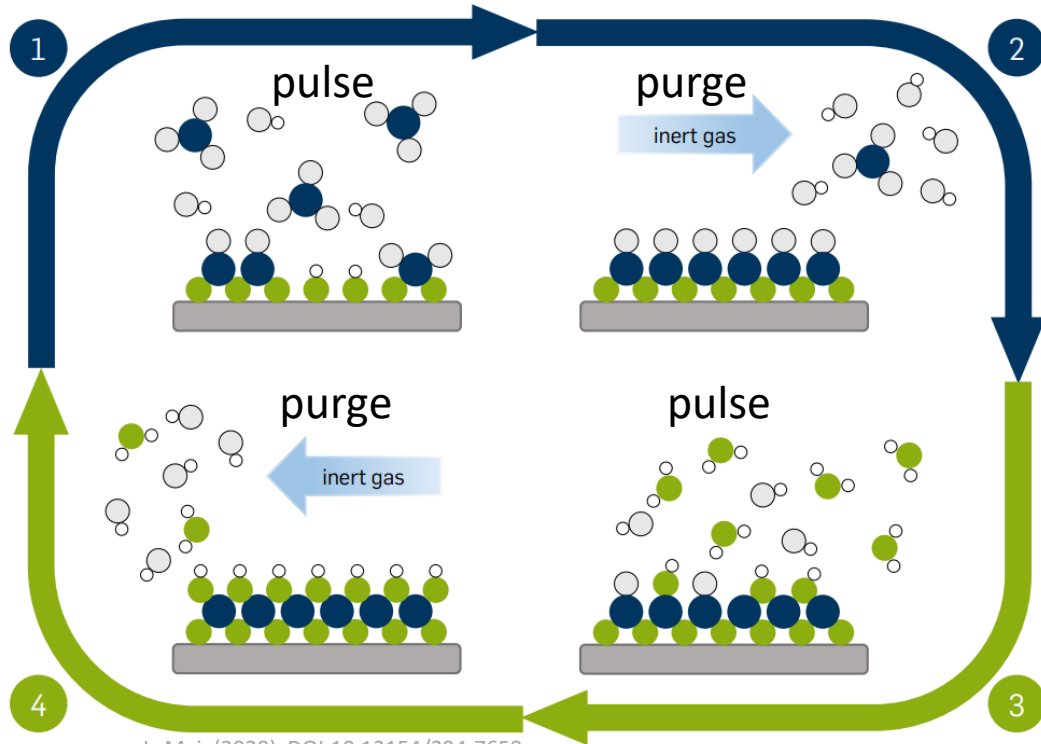
Thermal ALD cycle



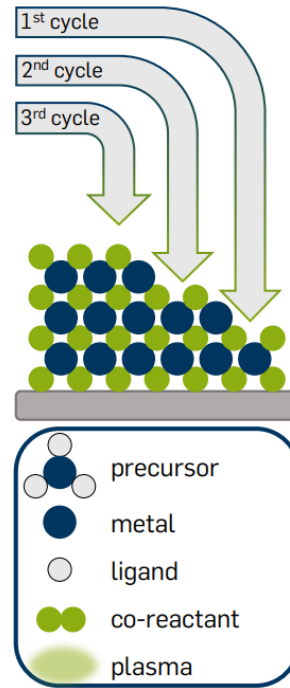
L. Mai, (2020), DOI:10.13154/294-7658

Thermal ALD vs plasma-enhanced ALD (PEALD)

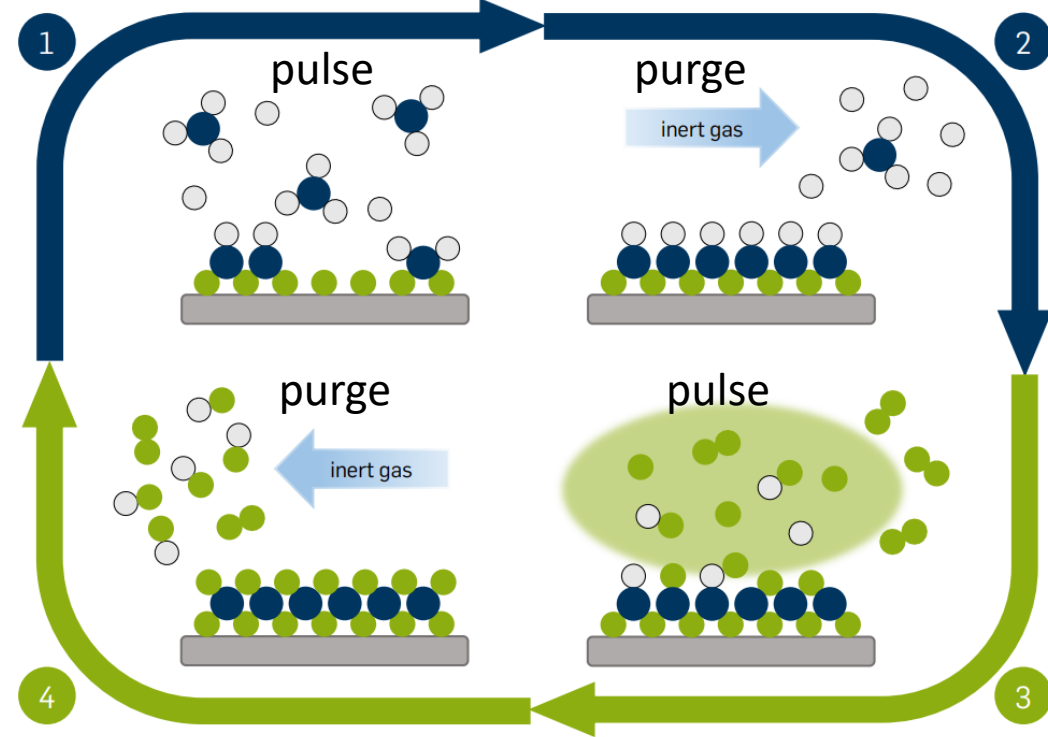
Thermal ALD cycle



Growth per cycle (GPC)

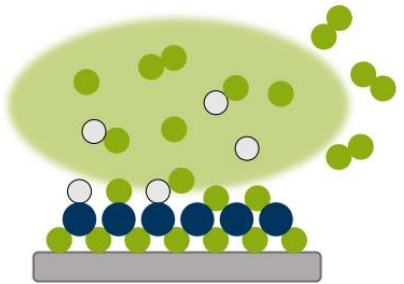


PEALD cycle



L. Mai, (2020), DOI:10.13154/294-7658

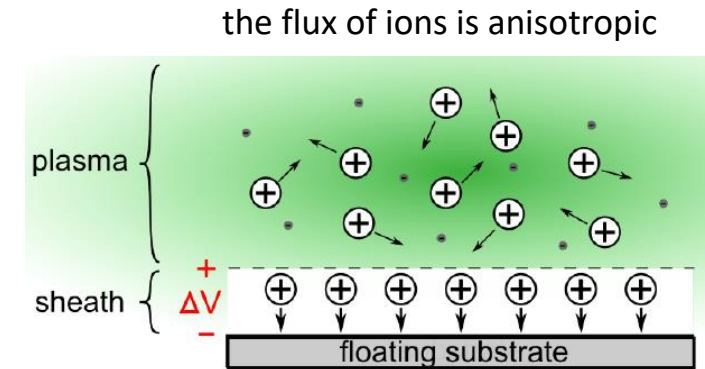
The role of plasma species in PEALD



Plasma species

e^- — ions — excited species — **radicals**

deliver high **reactivity** and energy to the surface
without heating the substrate



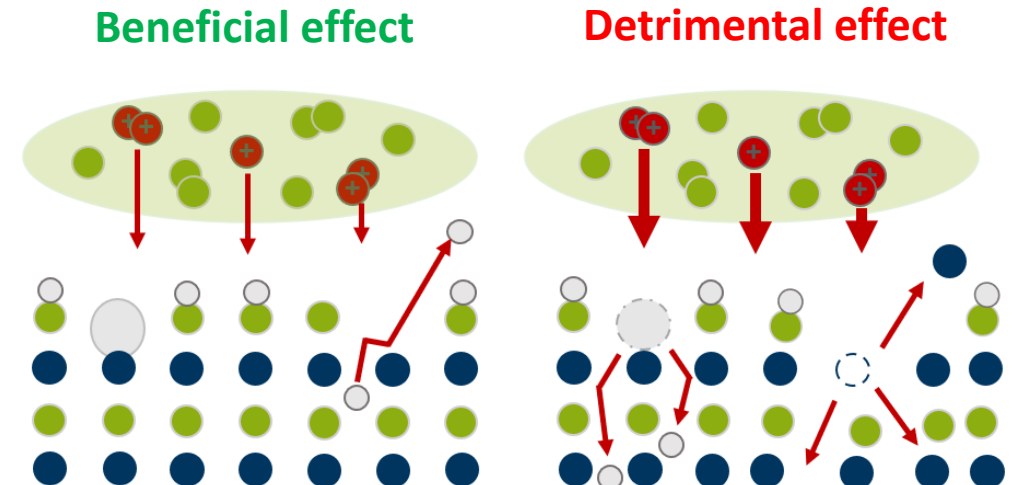
Kessels, E. (2023) PEALD AVS Seminar

MERITS

- ✓ Reduced deposition temperature
- ✓ Increased choice of precursors
- ✓ Improved material properties
(*better crystallinity, denser films, reduced impurities*)

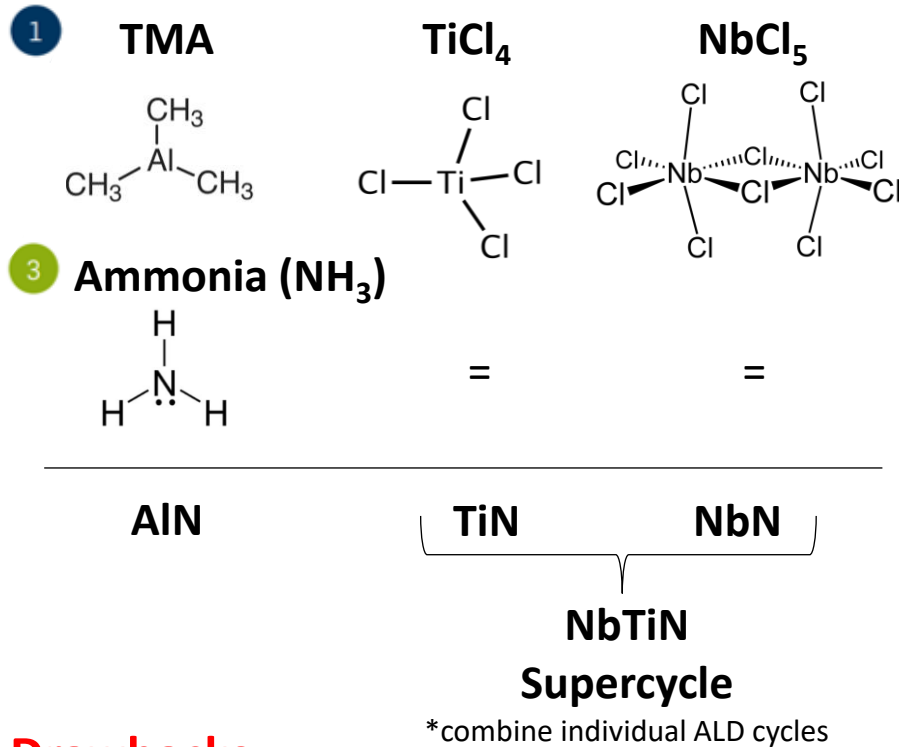
LIMITATIONS

- Plasma-induced damage (ions, radiation)
- Conformality limited (radical recombination, ion flux)
- Additional complexity



Thermal ALD vs PEALD of AlN and NbTiN

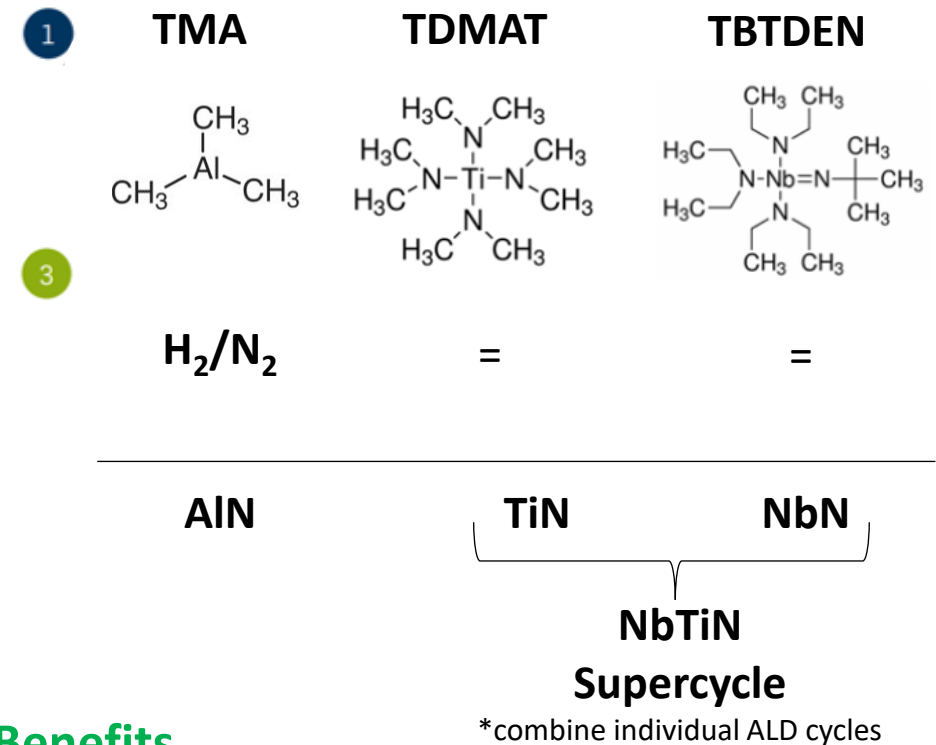
Thermal ALD cycle



Drawbacks

- Deposition temperature 450 °C
- Additional reducing Zn pulse
- HCl byproducts and Cl impurities
- NbCl₅ etches TiN – more TiN cycles

PEALD cycle



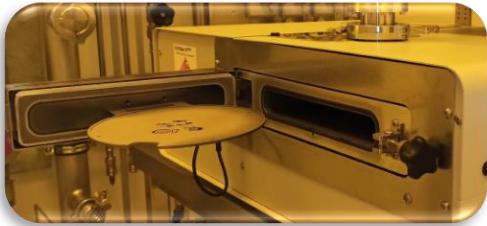
Benefits

- Lower deposition temperature < 300 °C
- Potential impurities are C and H
- Expected higher crystalline order

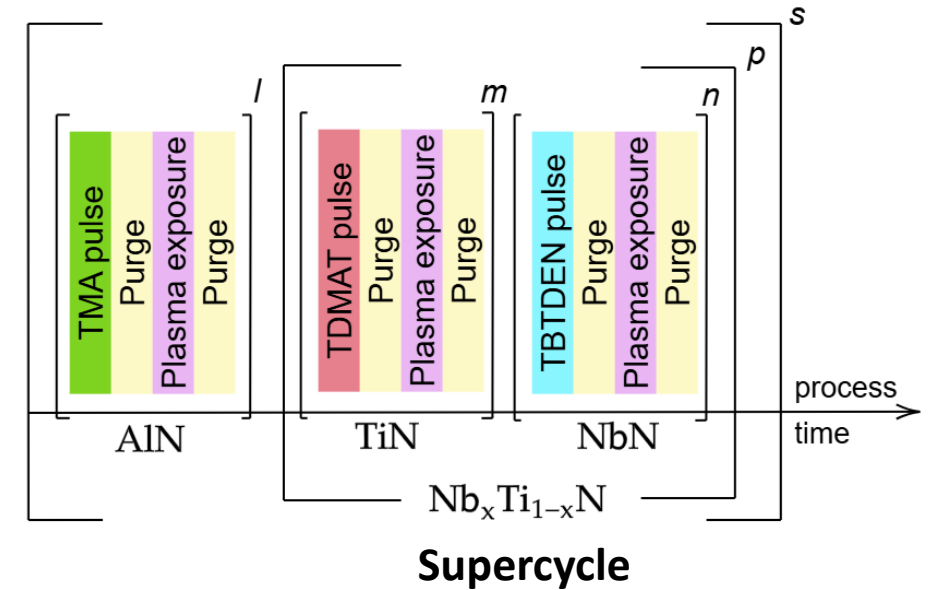
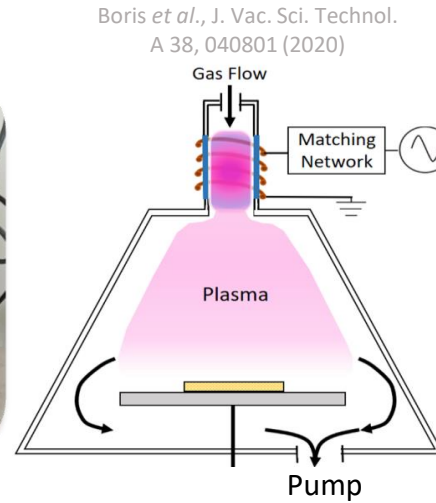
Growing AlN-NbTiN multilayers by PEALD on planar substrates

PEALD setup: GEMStar XT-P remote inductively-coupled plasma (ICP)

Deposition at 250 °C



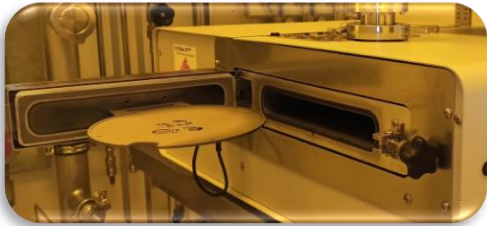
Planar substrates



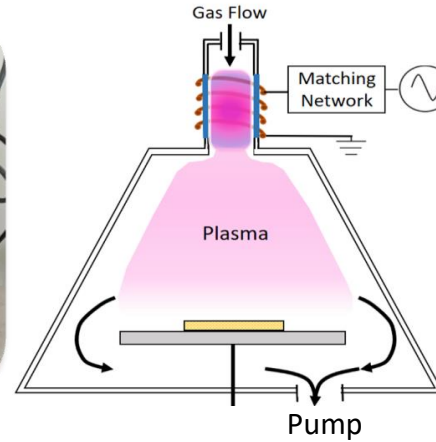
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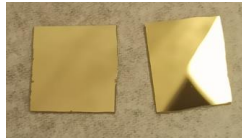
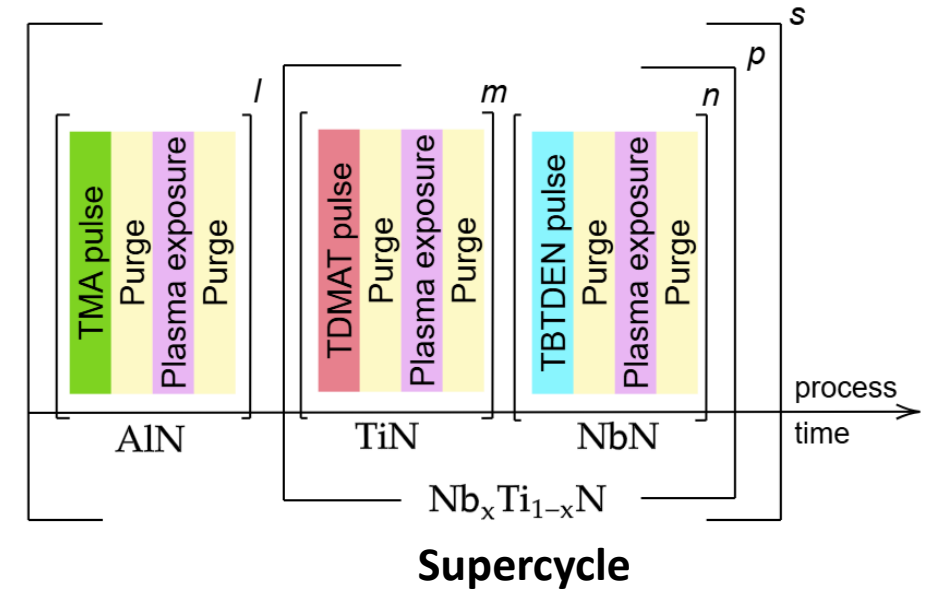
Deposition at 250 °C



Boris *et al.*, J. Vac. Sci. Technol.
A 38, 040801 (2020)



Planar substrates



Si wafers: XRR, EDS, XPS, XRD, ETO, VSM, SEM, STEM, AFM



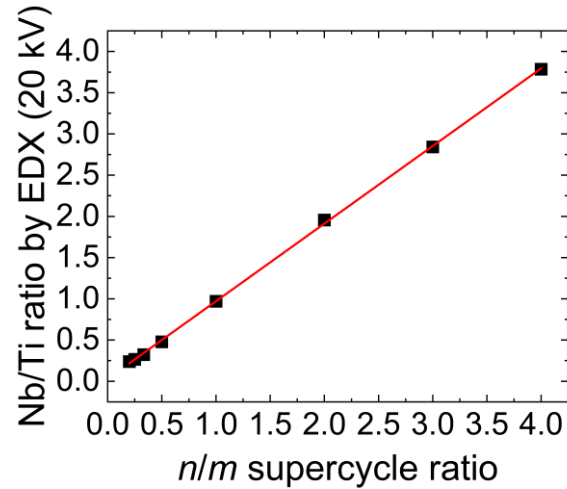
Standard cavity
surface preparation

Nb substrates: SAED, STEM, SEM, EDS, VSM, T_c station

Characterization

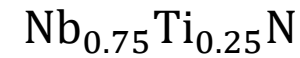
Tailoring NbTiN films

- $\text{Nb}_x\text{Ti}_{1-x}\text{N}$ films of various compositions varying the ratio of NbN to TiN cycles (n to m) inside the supercycle

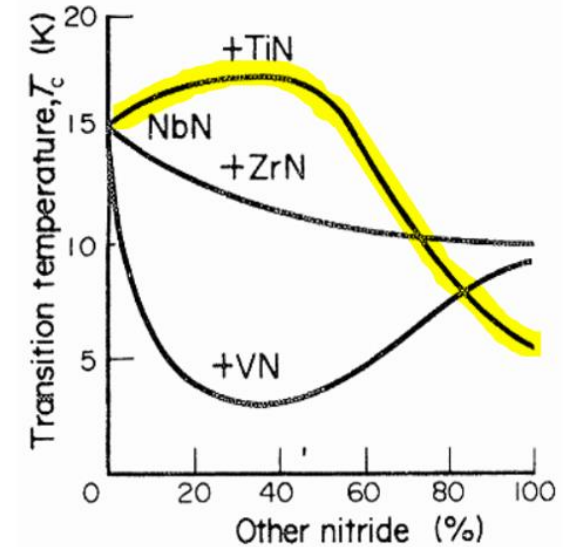


PEALD offers good control over the elemental composition

Optimal composition

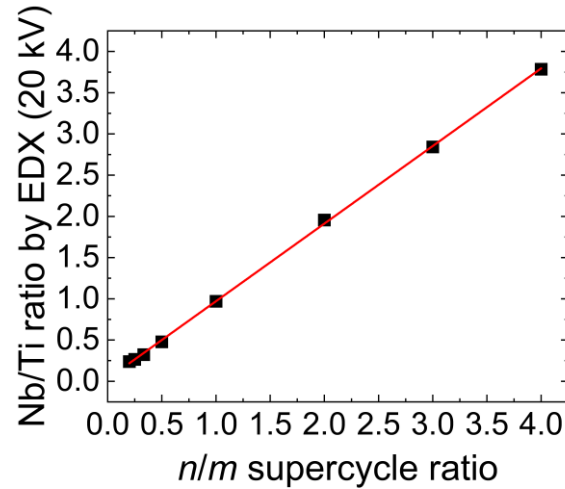


V. Palmieri SRF Workshop 2001



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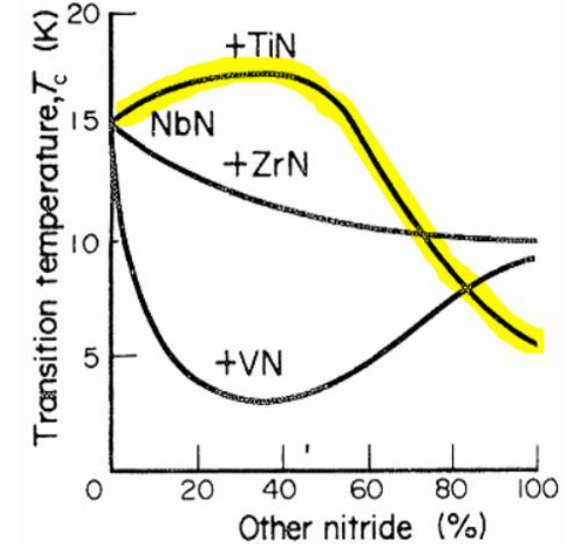


PEALD offers good control over the elemental composition

Optimal composition
 $\text{Nb}_{0.75}\text{Ti}_{0.25}\text{N}$

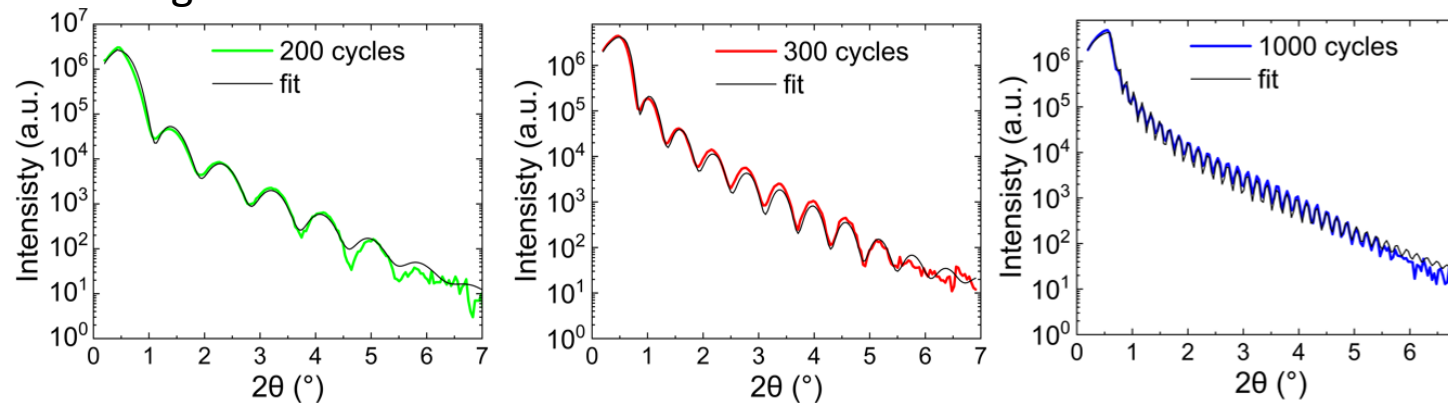


V. Palmieri SRF Workshop 2001



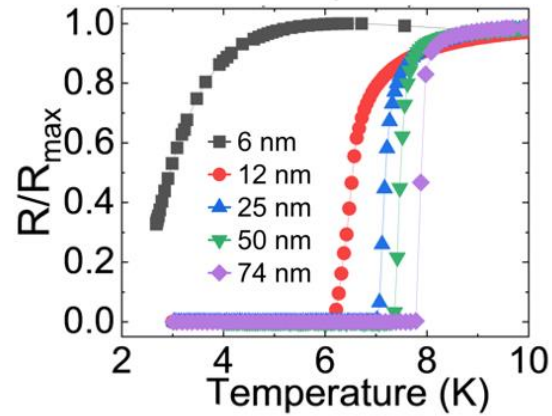
- GPC determination: $\text{GPC}_{\text{Supercycle NbTiN}} \approx 1 \times \text{GPC}_{\text{TiN}} + 3 \times \text{GPC}_{\text{NbN}}$

E.g.: XRR curves for NbN films of various thicknesses



Low T_c limits as-deposited NbTiN films for SRF cavity application

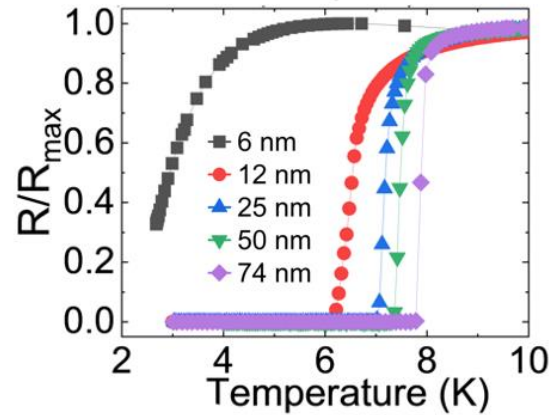
- Transport characterization revealed low T_c



PEALD $T_c^{\text{NbTiN}} < T_c^{\text{Nb}}$

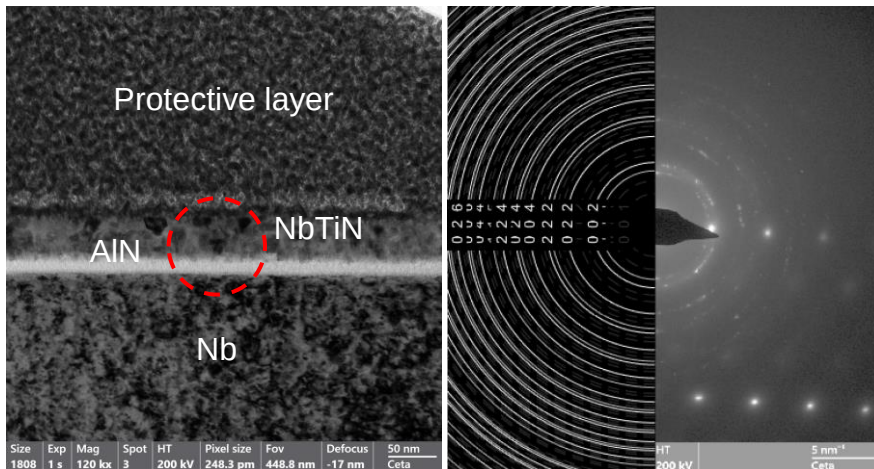
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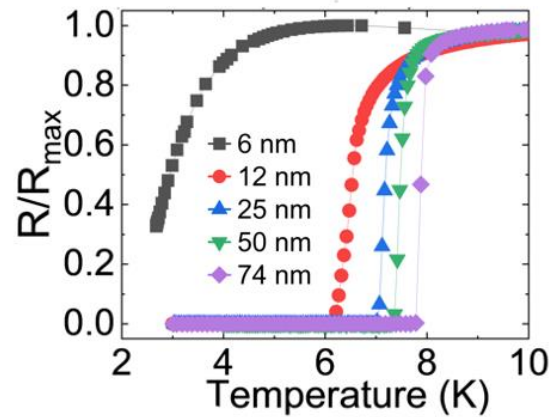
PEALD $T_c^{\text{NbTiN}} < T_c^{\text{Nb}}$

- Selected area electron diffraction (SAED):
ring indexing of the diffraction pattern $\rightarrow \delta\text{-NbTiN}$



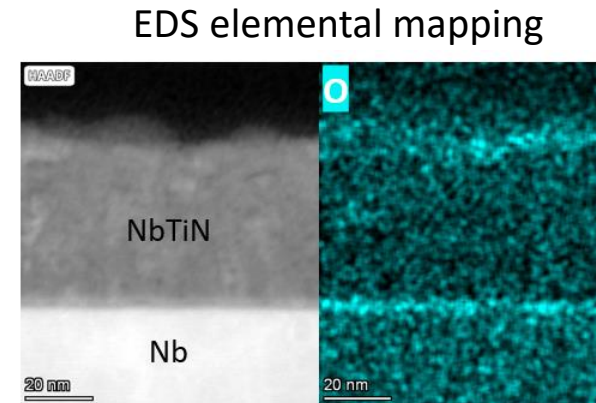
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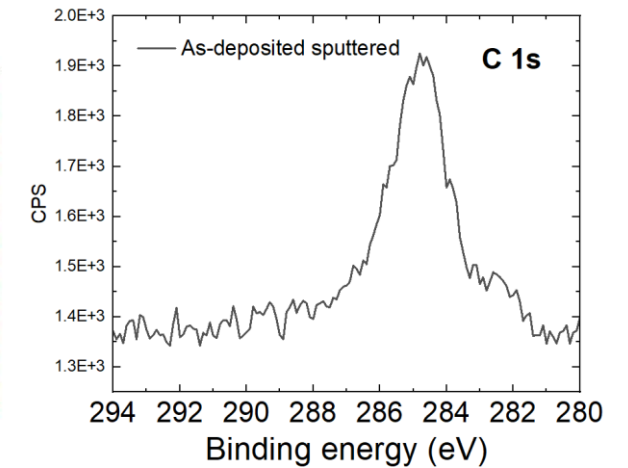


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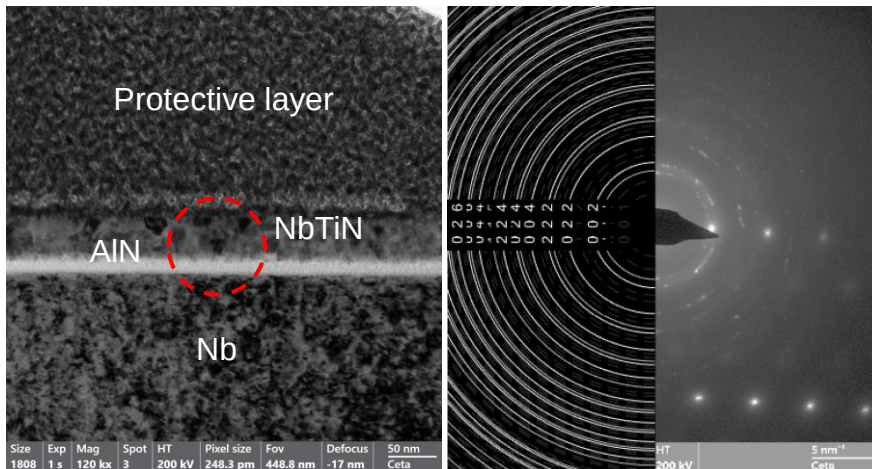
- Compositional analysis revealed oxygen and carbon contaminants



Carbon XPS peak

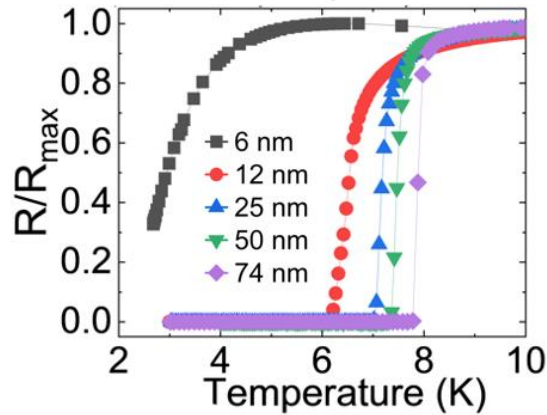


- Selected area electron diffraction (SAED):
ring indexing of the diffraction pattern $\rightarrow \delta$ -NbTiN



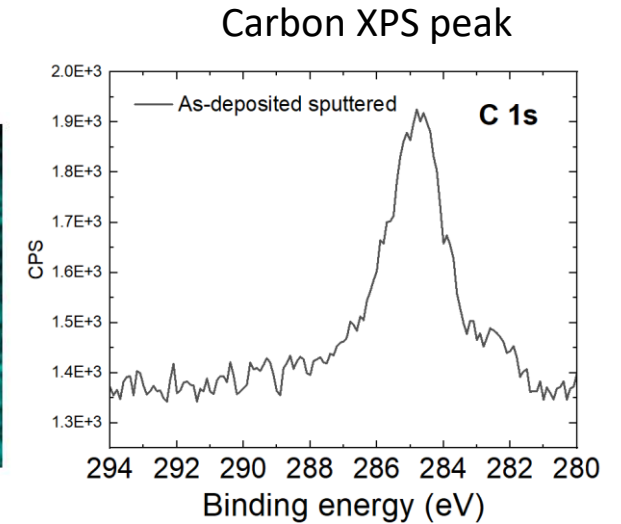
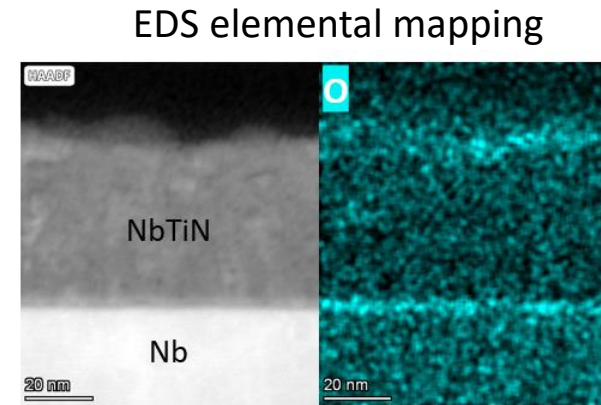
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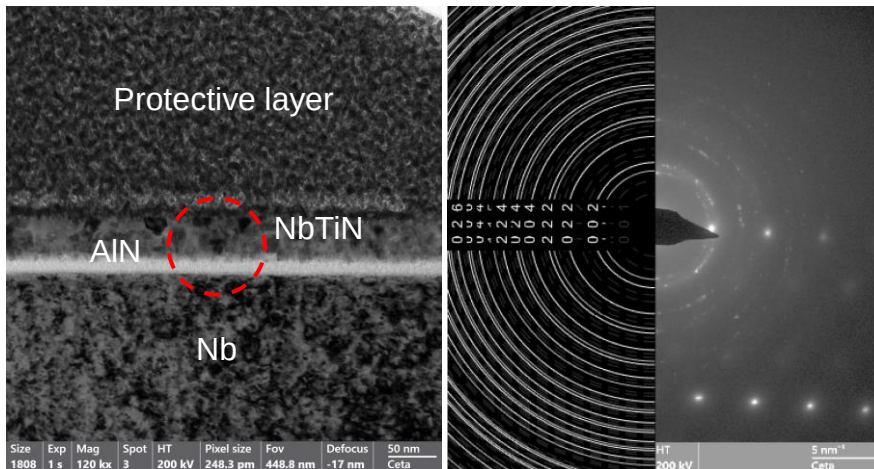


PEALD $T_c^{\text{NbTiN}} < T_c^{\text{Nb}}$

- Compositional analysis revealed oxygen and carbon contaminants



- Selected area electron diffraction (SAED): ring indexing of the diffraction pattern $\rightarrow \delta$ -NbTiN



***As-deposited:** Si-NbTiN, Si-AlN-NbTiN, Nb-NbTiN, Nb-AlN-NbTiN

- x $T_c^{\text{NbTiN}} < T_c^{\text{Nb}}$
- ✓ Crystalline δ -NbTiN
- x Small grains – high density of grain boundaries
- x Impurities from PEALD process

Annealing is required to degas impurities and promote grain growth

Post-deposition annealing is necessary to meet SRF criteria

- Various annealing procedures were investigated

Optimized annealing:

Base pressure: UHV (10^{-8} mbar)

Temperature: 900 – 1000 °C

Duration: 1 h

Heating rate: 3 °C/min

Atmosphere: vacuum

As-deposited vs **Annealed**

$T_c \approx 8 \text{ K} \rightarrow T_c \approx 16 \text{ K}$

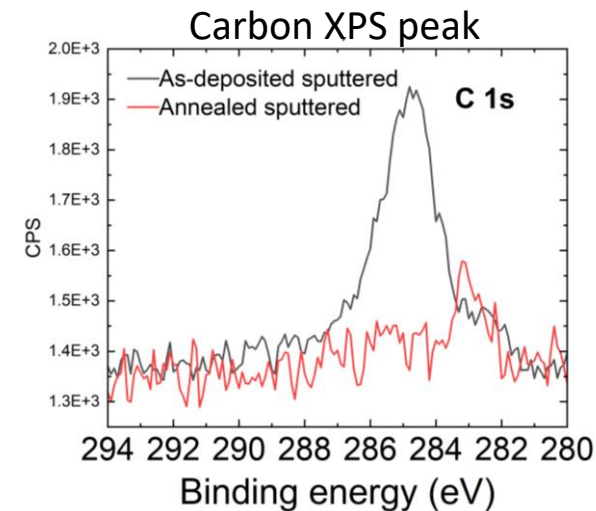
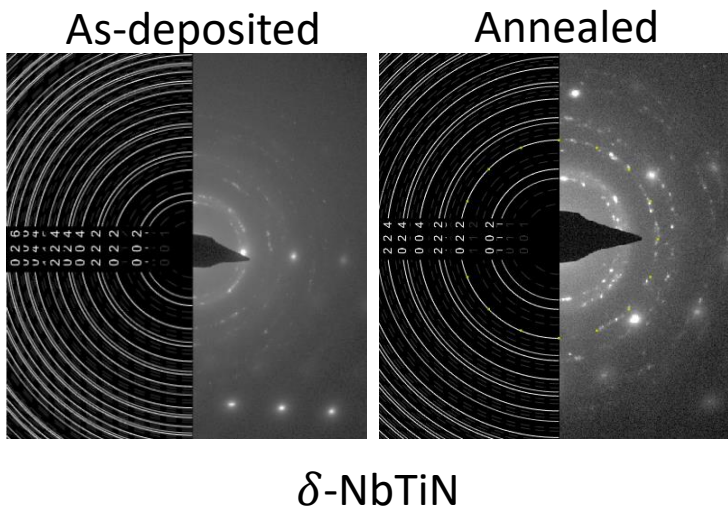
$B_{c1} \approx 15 \text{ mT} \rightarrow B_{c1} \approx 98 \text{ mT}$

$B_{c1}^{\text{film}} > B_{c1}^{\text{bulk}} = 30 \text{ mT}$

**Annealed AlN-NbTiN
multilayers meet SRF
criteria**

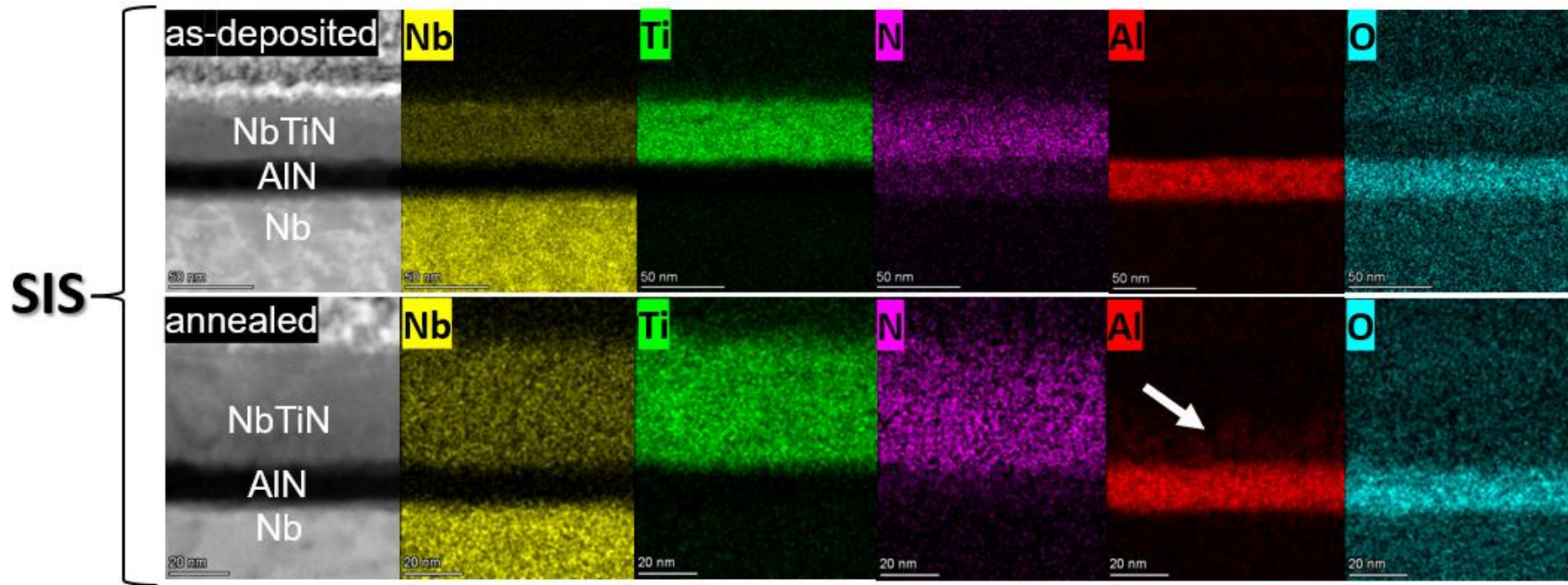
- **Enhanced crystallinity** for Si-NbTiN, Si-AlN-NbTiN, Nb-AlN-NbTiN (**not for Nb-NbTiN**)

- Annealing results in **carbon degassing** (unclear for oxygen)



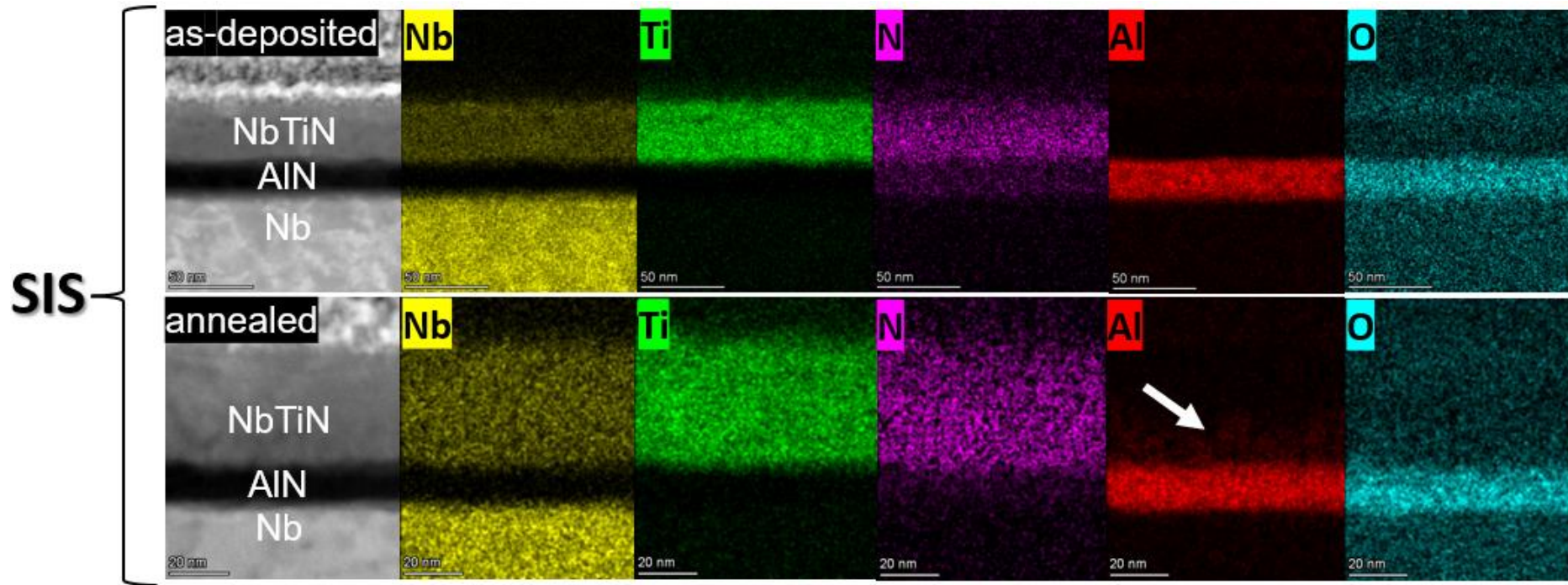
Annealing results in Al diffusion

- EDS elemental mapping indicated that annealing caused Al diffusion into the NbTiN film (also for Si substrate)

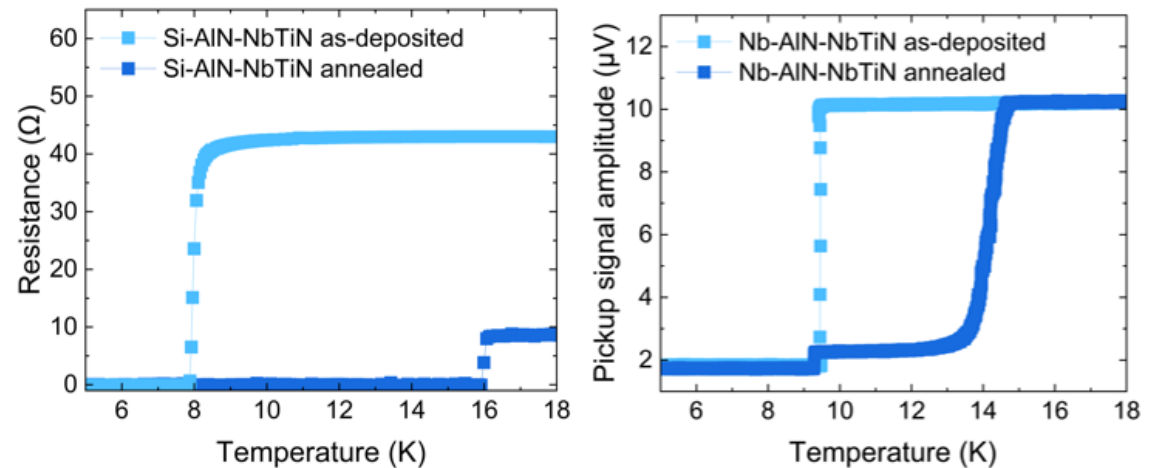


High T_c is reached regardless of Al diffusion

- EDS elemental mapping indicated that annealing caused intermixing at the AlN-NbTiN interface(also on Si substrate)

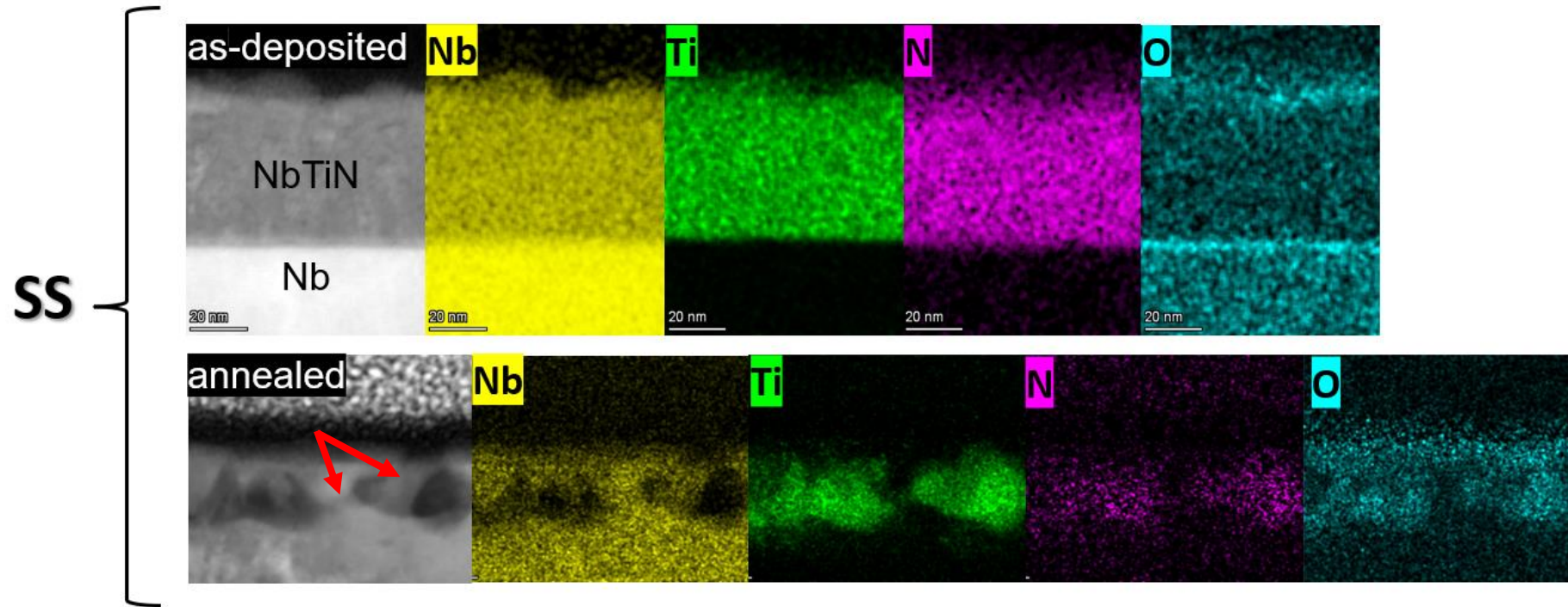


- Al diffusion does not prevent to achieve a high T_c



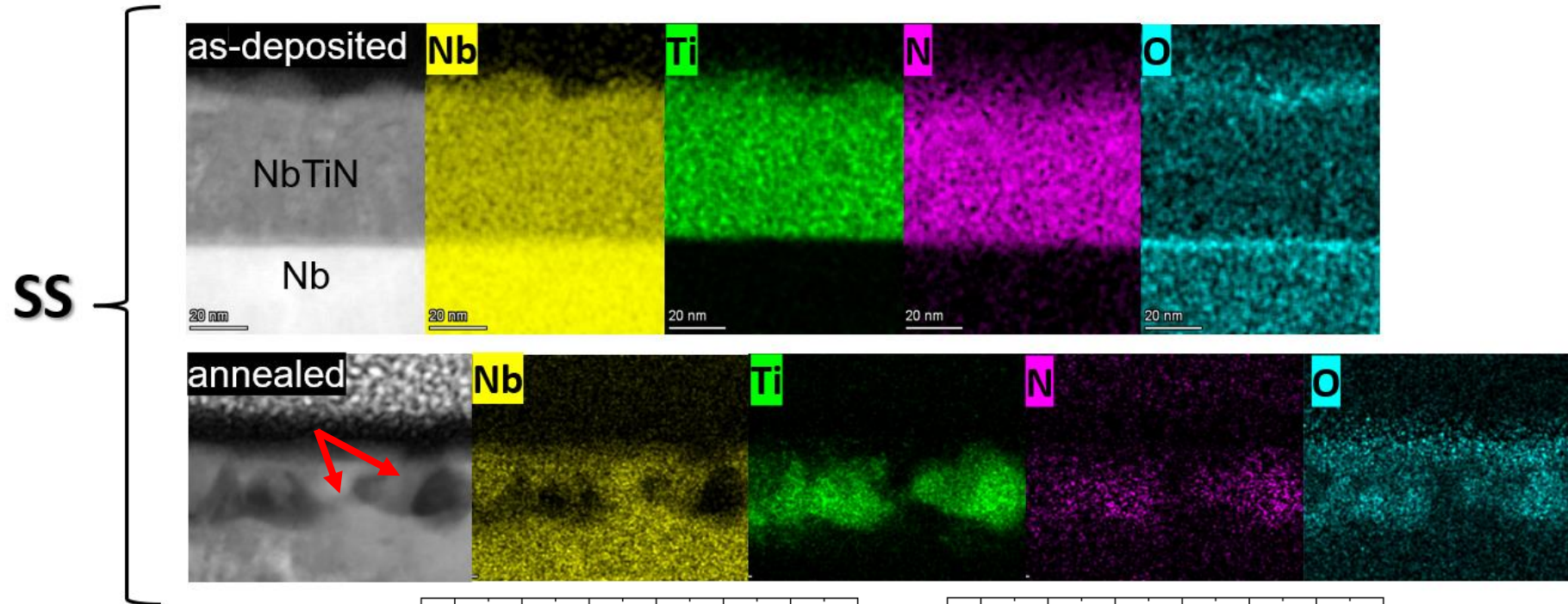
AlN layer is essential for the annealing success

- EDS elemental mapping indicated **Nb and Ti clusters** caused by the annealing (**not for Si substrate**)

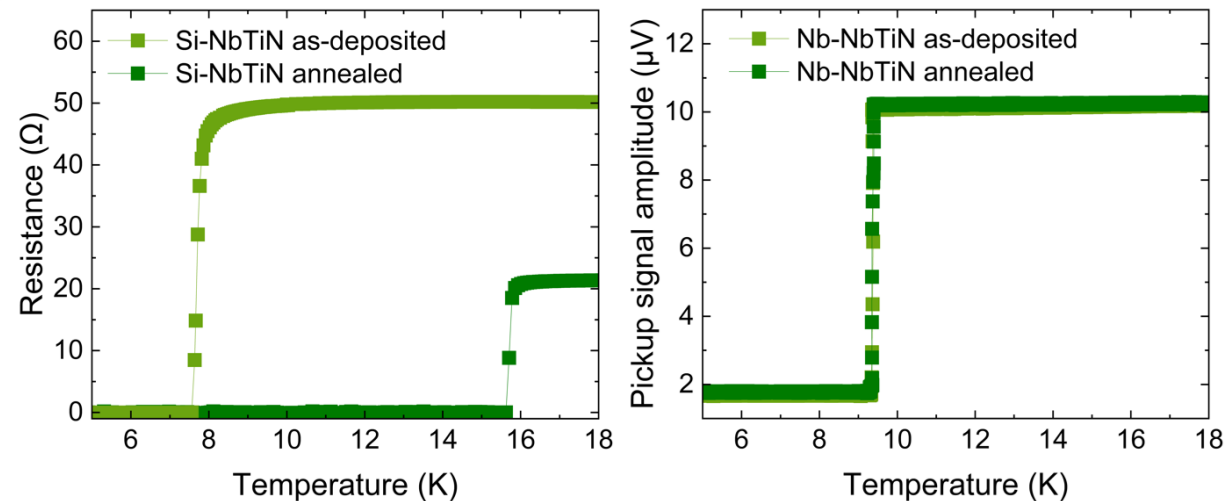


AlN layer is essential for the annealing success

- EDS elemental mapping indicated **Nb and Ti clusters** caused by the annealing (**not for Si substrate**)



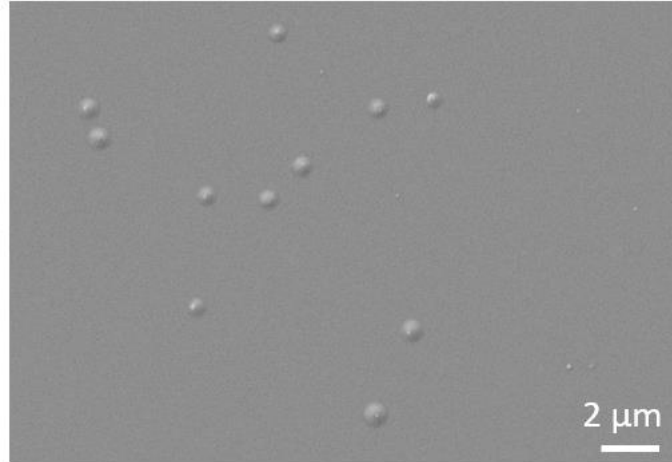
- Nb and Ti clusters
- **no right phase formation**
- **no high T_c**



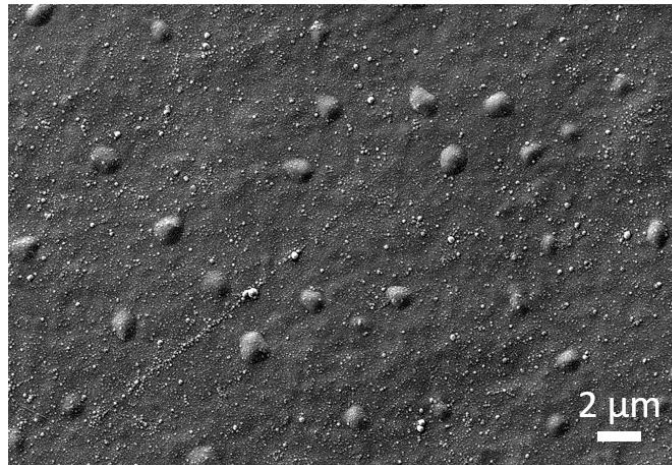
Morphological defects that could limit the cavity performance

➤ Blisters formation: Plasma-induced

On Si



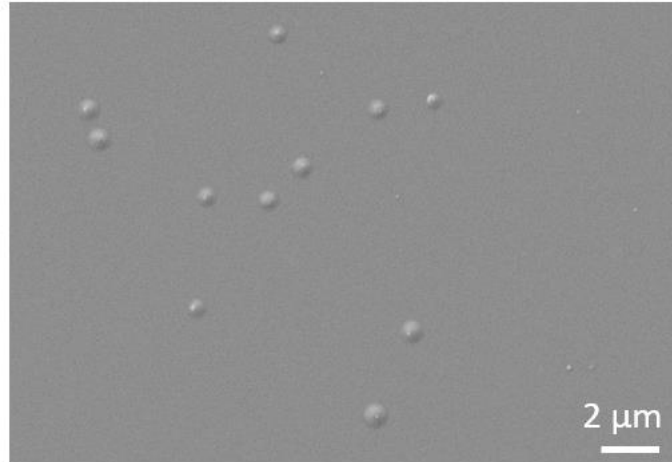
On Nb



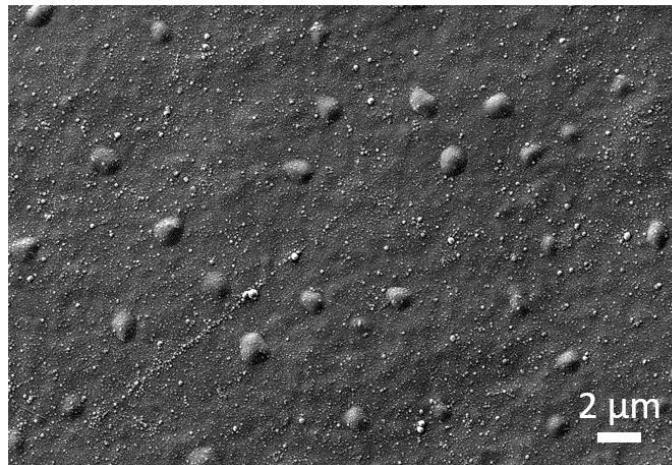
Morphological defects that could limit the cavity performance

➤ Blisters formation: Plasma-induced

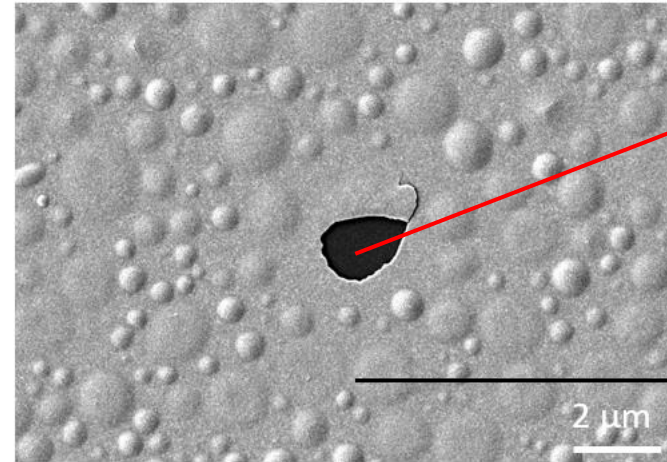
On Si



On Nb

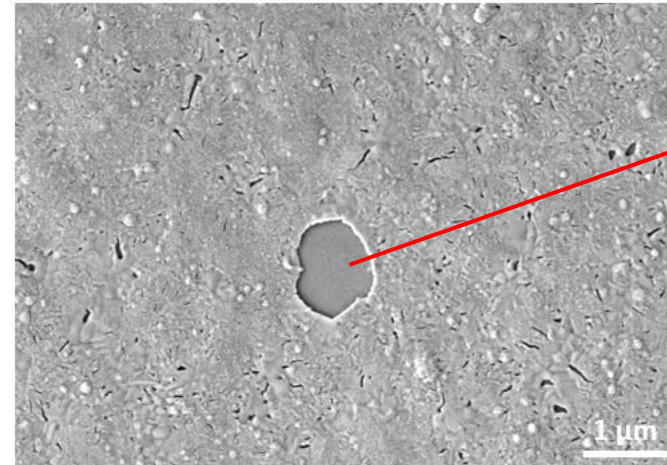


➤ Annealing-induced defects



Blisters result in peel-off with annealing

Different thermal expansion coefficients between substrate and layers



Blisters result in peel-off with annealing

No thermal expansion issues

Conclusions

Achievements

Synthesize AlN-NbTiN by PEALD

- ✓ On Si and on Nb (surface treated as SRF cavities)
- ✓ Tailor the NbTiN composition
- ✓ Characterizations: XRD, SAED, STEM, SEM, EDS, XPS, ETO, VSM, T_c station, XRR, SE, AFM

As-deposited films

- Low quality NbTiN (δ -NbTiN, $T_c^{\text{NbTiN}} < T_c^{\text{Nb}}$, $B_{c1}^{\text{film}} < B_{c1}^{\text{bulk}}$)
- Blisters formation

Post-deposition annealing

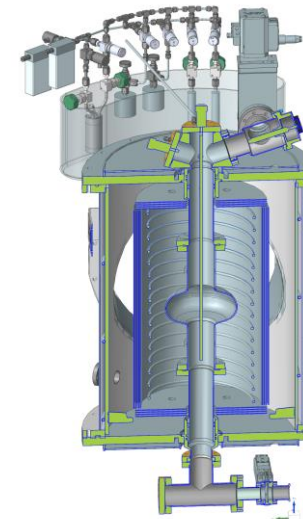
- Enhanced crystallinity and degas of impurities
- Films meet SRF criteria ($T_c^{\text{NbTiN}} > T_c^{\text{Nb}}$, $B_{c1}^{\text{film}} > B_{c1}^{\text{bulk}}$)
- AlN layer is essential for the annealing success
- Blisters result in peel-off

Next steps

Further characterization

- ✓ Multilayers resist HPR (standard cavity treatment)
- Thermal transmittance (ongoing)
- Flux trapping studies (ongoing)
- RF test with QPR or cavity (missing)

From planar substrates to 1.3GHz cavities (ongoing)



PEALD-SINGLE-CELL
COATING SYSTEM

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